

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: Hiroshi Fukui

Confirmation No.: 7869

Serial No.: 10/533,849

Filed: October 24, 2005

Group Art Unit: 1796

Examiner: Loewe, Robert S.

For: HEAT CONDUCTIVE SILICONE COMPOSITION

**AMENDMENT**

Mailstop AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Dear Sir:

In response to the Office Action dated September 12, 2008, please amend the claims as follows and consider the accompanying remarks. A complete listing of all claims pending in the application is included in accordance with 37 CFR § 1.121. This response is timely filed; thus, it is believed that no fees are presently due.